COMEX-TESTKIT-1

Carrier Board

Micro-ATX Form Factor, COM-Express Type 6 so that customer can evaluate many interfaces





FEATURES

- Revision 3.0 (comply with newer revision)
- Type 6 (6 is for standard, whereas 7 is for server and 10 is for mobile)
- Supporting Basic and Compact form factors
- Micro-ATX dimension
- Port 80/81 debug port
- Mini-PCle slots & M.2 Key B support
- Operating in temperatures ranging from 0 to 60°C
- Accommodates both ATX and DC power inputs for versatile applications.





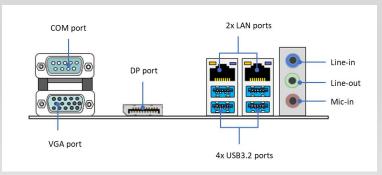
Automotive Industry



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I/O Panel View

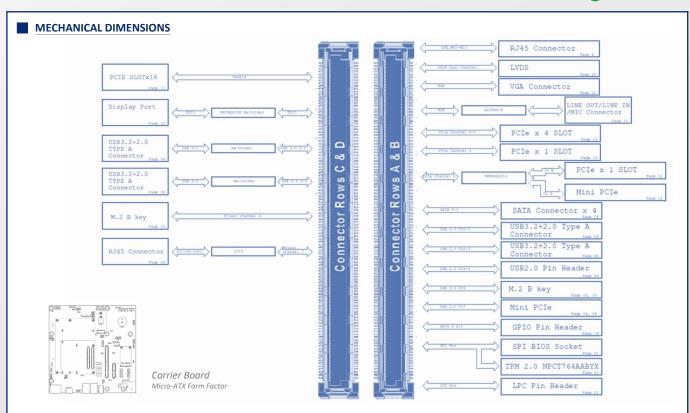


Application

The COMEX-TESTKIT-1 carrier Board excels in manufacturing, healthcare, and digital signage. With advanced features, rich connectivity, and robust reliability, it epitomizes efficiency across diverse industries.

Ver. 0.90





Specifications	
Model No.	COMEX-TESTKIT-1 (TBD)
Socket	COM-Express Type 6
Audio	Audio Jack Line-in/ Line-out/ Mic-in (Rear I/O)
Storage Devices	4 x SATA 3.0, 4x SATA Power Connector
Expansion Interface	1 x Full-sized Mini PCle 1 x M.2 Key B Type 3052 with LTE nano-SIM holder 1 x PClex16 1 x PClex4 2 x PClex1
Ethernet	2 x 10/100/1000 BASE-Ton internal pin header by Intel®i210-AT controller
USB Port	4 x USB 3.2 Gen2 ports on rear I/O (Type A connector) 2 x USB 2.0 port by Internal pin header
Serial Port	1 x RS-232/422/485 port by Internal pin header 1 x RS-232 port on rear I/O
GPIO	8-bit general purpose input output I/O connector by Internal pin header
Display Interface	1 x DisplayPort 1.4 on rear I/O 1 x VGA on rear I/O 1 x LVDS support Dual channel 24 bits
ТРМ	Onboard TPM 2.0
Front panel I/F	Power Supply Button , Reset , SLP by Internal pin header
Power Supply	12VDC±10% , 2x4pin power connector
Environment	Operation Temperature: 0 to 60°C (TBD) Storage Temperature: -40 to 80 °C (TBD) Relative Humidity: 5% to 95%, noncondensing

Ordering Guide	
COMEX-TESTKIT-1	Supporting Basic and Compact form factors with Micro-ATX, COM-Express Type 6